504551232 09/18/2017

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HIDEKI SHIGEMATSU	08/08/2017
MASAFUMI SAITO	08/08/2017
KEITA MIYASHITA	08/08/2017
RYUZO SAKAMOTO	08/08/2017
HIROYUKI MIYAJIMA	08/21/2017
AKIO KOMAMURA	08/21/2017

RECEIVING PARTY DATA

Name:	HONDA MOTOR CO., LTD.
Street Address:	1-1, MINAMI-AOYAMA 2-CHOME
Internal Address:	MINATO-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	107-8556
Name:	SHINKO ELECTRIC INDUSTRIES, CO., LTD.
Street Address:	80, OSHIMADA-MACHI
City:	NAGANO-SHI, NAGANO
State/Country:	JAPAN
Postal Code:	381-2287

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	15706802

CORRESPONDENCE DATA

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504551232 REEL: 043610 FRAME: 0806

PATENT

ATTORNEY DOCKET NUMBER:	SHO-42716
NAME OF SUBMITTER:	DAVID E. SPAW
SIGNATURE:	/David E. Spaw/
DATE SIGNED:	09/18/2017
Total Attachments: 3	
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PATENT REEL: 043610 FRAME: 0807

ASSIGNMENT

WHEREAS, new and useful improvements have been made by the undersigned in	
Title of Invention:	PEELING APPARATUS AND PEELING METHOD
that are the subject filed September 18, 2	of an application for a U.S. Patent, (Application No. 15/706802

LLP Docket No. SHO-42716.

WHEREAS, (1) HONDA MOTOR CO., LTD., a corporation of Japan, and having a place of business at 1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo, 107-8556, Japan, and (2) SHINKO ELECTRIC INDUSTRIES CO., LTD., a corporation of Japan, and having a place of business at 80, Oshimada-machi, Nagano-shi, Nagano, 381-2287, Japan, hereinafter referred to as "assignee", is desirous of acquiring all right, title, and interest throughout the world in, to, and under said improvements and inventions and patent rights therefor.

NOW, THEREFORE, be it known that, for valuable consideration, the receipt and sufficiency of which are hereby acknowledged, all right, title, and interest, in the United States and throughout the world, in, to and under said improvements and inventions and all patents, patent applications, patent rights, and inventor's certificates thereof, therefor, and therein, including without limitation said application for patent in the United States, all divisions and continuations thereof, all patents which may be granted thereon, all reissues and extensions thereof, all right to sue for past infringement thereunder, all patents which may be granted for said improvements and inventions by states or nations other than the United States, or by other authority, entity, or organization, and all applications therefor, have been and are hereby sold, assigned, transferred, and delivered unto assignee, its successors and assigns; and it is covenanted and agreed by the undersigned, and for executors, administrators, and legal representatives of the undersigned, that at assignee's request any and all applications, affidavits, assignments, and other instruments will be made, executed, and delivered as may be necessary, or desirable to secure for or vest in assignee, its successors or assigns, any improvement, inventions, right, title, interest, application. patent, patent right or other right or property covered by this assignment, and the United States Commissioner of Patents and Trademarks is hereby requested and authorized to issue any and all United States patents granted on any of said applications to assignee as owner of the entire right, title, and interest in, to, and under the same, and appropriately empowered officials of foreign countries are hereby authorized to issue any letters patent granted on any of said applications to assignee as owner of the entire right, title and interest in, to, and under the same.

The undersigned hereby grants the firm of Rankin, Hill & Clark LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

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IN WITNESS WHEREOF, this assignment has been executed below by the $\mbox{\it undersigned}\colon$

(1)	Inventor Name (joint): Keita Miyashita
	Signature: <u>Keita Miyashita</u>
	Today's Date: August 8, 2017
	Witness:
	Witness:
, m. l.	
(2)	Inventor Name (joint): Hideki Shigematsu
	Signature: 7 didelad Shigematsu
	Today's Date: August 8, 2017
	Witness:
	Witness:
(3)	Inventor Name (joint): Masafumi Saito
	Signature: <u>Masafumi Saito</u>
	Today's Date: August 8, 2017
	Witness:
	Witness:
(4)	Inventor Name (joint): Ryuzo Sakamoto
	Signature: <u>Dyung Schamato</u>
	Today's Date: August 8, 2017
	1APA
	Witness:
	Witness:

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(5)	Inventor Name (joint): <u>Hiroyuki Miyajima</u>
	Signature: <u>Miroyuki Miyajima</u>
	Today's Date: August 21, 2017
	Witness:
	Witness:
(6)	Inventor Name (joint): Akio Komamura
	Signature: Akto Komamuta
	Today's Date: August 21, 2017
	Witness:
	Witness:
(7)	Inventor Name (joint):
	Signature:
	Today's Date:
	Witness:
	Witness:
(8)	Inventor Name (joint):
	Signature:
	Today's Date:
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	Witness:
	Witness:

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